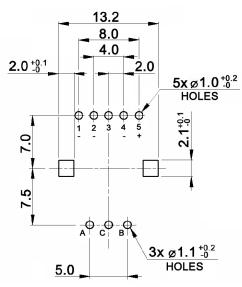
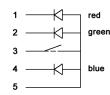


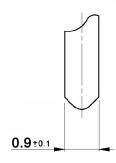
P.C.B. MOUNTING (TOLERANCE ±0.1) VIEWED FROM MOUNTING SIDE t=1.4mm



CIRCUIT DIAGRAM



TERMINAL DETAIL



Compliance: RohS III (2015/863/EU)

Modifications

				,
Tolerances:	_		Date	Name
	10-100: ·	±0.5mm	10/14	dr

MERP12-24N225M

Case height 06/22 dr Knitter-switch

Date Name

30 31 95

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General

- 1.1 Application: This specification applies to the 12mm size rotary encoder (incremental) for microscopic current circuits used in electronic equipment.
- 1.2 Standard atmospheric conditions

Unless otherwise specified the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature: 15°C to 35°C Relative humidity: 25% to 85% Air pressure: 86kpa to 106kpa

If there is any doubt the results, measurement shall be made within the follow limits:

Ambient temperature: 20°C±2°C Relative humidity: 60% to 70% Air pressure: 86kpa to 106kpa

- 1.3 Operating temperature range: -10°C to +70°C
- 1.4 Storage temperature range: -40°C to +85°C
- 1.5 Construction and dimensions: Refer to attached drawing.
- 1.6 Rating: D.C 5V 0.5mA

Electrical characteristics

NO.	Items	Test conditions	Specifications
2. 1	Resolution		24 pulses / 360° for each phase.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/03/23	2010/03/23	2010/03/23

NO.	Items	Test co	nditions	Specifications
2, 2	Output signal format			2 Phase-different signals (Signal A. & signal B)
		Shaft rotational	Signal	Output 360°
		direction	Signai	constant speed: 360°
			A (Terminal A-C)	OFF ON
		C. W.	B (Terminal B-C)	OFF ON
			A (Terminal A-C)	OFF ON
		C, C, W.	B (Terminal B-C)	OFF ON
2. 3	Switching characteristics	Measurement shall be made follows. (1) Shaft rotational spect(2) Test circuit: <fig. 2=""> <fig. 2=""></fig.></fig.>	ed:360°/S	
		Terminal A Φ ENCODER =	DC5V 10KΩ Terminal B Terminal C	

					NOTE	APPD	CHKD	DSDG
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NO.	Items	Test conditions	Specifications
2. 4	Sliding Noise	(1) Chattering Details shown in <fig. 3="">. Specified by the signal's passage time from 3.5V to 1.5V or from 1.5V to 3.5V of each switching position (code OFF →ON or ON→OFF).</fig.>	t1,t3 ≦ 3ms
		Note: To avoid chattering (t1,t3), please consider masking time and adding C/R filters on your circuit for pulse count design, as show in <fig.4></fig.4>	
		(2) Bounce	t2 ≦ 2ms
		Details shown in <fig. 3="">. Specified by the time of voltage change exceed 1.5V in code-ON area. When the bounce has code-ON time less than 1 ms between chattering (t1 or t3), the voltage change shall be regarded as a part of chattering. When the code-ON time between 2 bounces is less than 1 ms. they are regarded as 1 linked bounce.</fig.>	
		(3) Sliding noise	3.5V以上 (MIN)
		The voltage change in code-OFF area.	
		<fig. 3=""> <fig.< td=""><td>4></td></fig.<></fig.>	4>
			Terminal B KΩ 10ΚΩ 10ΚΩ ENCODER OTERMINAL B CONTROL DC5V B CONTROL DC5V CONT
		Code-OFF area: The area which the voltage is 3.5V or Code-ON area: The area which the voltage is 1.5V or	

					NOTE	APPD	CHKD	DSDG
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NO.	Items	Test conditions	Specifications
2.5	Phase-difference	Measurement shall be made under the condition which the shaft is rotated in 360°/S (constant speed). <pre></pre>	result could be different
2.6	Insulation resistance	Measurement shall be made under the condition which a voltage of 250V D.C. is applied between individual terminals and attaching plate.	Between individual terminals and attaching plate: 100MΩ MIN.
2. 7	Dielectric strength	A voltage of 300V A.C. shall be applied for 1 min or a voltage of 360V A.C. shall be applied for 2 sec between individual terminals and attaching plate. (Leak current: 1mA)	Without damage to parts arcing or breakdown.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/05/25	2010/03/23	2010/03/23

Mechanical characteristics

NO.	Items	Test conditions	Specifications
3, 1	Total rotational angle		360°(Endless)
3, 2	Rotational torque		50gf.cm (MAX)
3, 3	Terminal strength	A static load of 300gf be applied to the tip of terminals for 1 minute in any direction.	Without damage or excessive Looseness of terminals. Terminal bend is permitted
3.4	Push-pull strength of shaft	Push and pull static load of 5Kgf shall be applied to the shaft in the axial direction for 10 sec. (After installing)	Without damage or Excessive play in shaft, No excessive abnormality in rotational feeling.
3, 5	Shaft wobble	A momentary load of 500gf.cm shall be applied at the point from the tip of the shaft in a direction perpendicular to the axis of shaft.	1.0xL/30 mmp-p (MAX) L:Shaft length.
3.6	Side thrust strength of shaft	A load of 2Kgf shall be applied at the point 5mm from the tip of the shaft in a direction perpendicular to the axis of shaft. (After soldering of the PC board)	Without damage or Excessive play in shaft. No excessive abnormality in rotational feeling.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
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Endurance characteristics

NO.	Items	Test conditions	Specifications
4. 1	Rotational life	The shaft of encoder shall be rotated to 30,000 cycles at a speed of 600~1000 cycles per hour without electrical load, after which measurement shall be made. (1 cycle: rotate 360°C.C.W. rotate 360°C.W.)	Chattering: t1, t3≤5ms Bounce: t2≤3ms Phase-difference: △T≥2.5msec Except above items. specifications in clause 2.1~7 and 3.1~6 shall be satisfied.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/03/23	2010/03/23	2010/03/23

Soldering condition

NO.	Items	Test conditions	Specifications
5, 1	Manual soldering	Bit temperature of soldering iron: 350°C or less Application time of soldering iron: within 3s.	There shall be no deformation or cracks in molded part. No excessive abnormality in rotational feeling.
5, 2	Dip soldering	Printed wiring board: Both-sided copper clad laminate board with thickness of 1.6mm. Flux: *Specific gravity: 0.82 or more. *Flux shall be applied to the board using a bubble foaming type fluxed. *The board shall be soaked in the flux bubble only to the 2/3 of its thickness. Preheating: *Surface temperature of board: 100°C or less. *Preheating time: within 2 min. Soldering: *Solder temperature: 260±5°C *Immersion time: 5±1 sec. Apply the above soldering process for 1 or 2 times.	There shall be no deformation or cracks in molded part. No excessive abnormality in rotational feeling.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/03/23	2010/03/23	2010/03/23

Switch Electrical characteristics

NO.	Items	Test conditions	Specifications
6. 1	Contact resistance	Measured by decides the electric current D.C. voltage drop method.	100 mΩ (MAX)
6, 2	Chattering	Switch is operated at the rate of 1 cycle 1 sec. The 1 cycle shall be OFF-ON-OFF.	10 msec (MAX)
6. 3	Insulation resistance	Measurement shall be made under the condition which a voltage of 250V D.C. is applied between individual terminals and attaching plate.	Between individual terminals and attaching plate: 100MΩ MIN.
6. 4	Dielectric strength	A voltage of 300V A.C. shall be applied for 1 min or a voltage of 360V A.C. shall be applied for 2 sec between individual terminals and attaching plate. (Leak current: 1mA)	Without damage to parts arcing or breakdown.
6, 5	Switch rating (Resistor load)		D, C, 5V 10mA

Note: Shaft is insulated from switch terminal.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/03/23	2010/03/23	2010/03/23

Switch Mechanical characteristics

NO.	Items	Test conditions	Specifications
7. 1	Contact arrangement		S. P. S. T (PUSH ON)
7. 2	Switching stroke		0.5 (+0/-0.3) mm
7. 3	Switch strength		450±200 gf

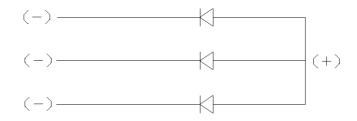
Switch Endurance characteristics

NO.	Items	Test conditions	Specifications
8. 1	Operating life	electronically load, after which measurements shall be made.	Switch contact resistance: 200mΩ MAX. Switch strength: Relative to the previously specified value +10%/-30%. Except above items Specification in clause 6.1~4 and 7.1~3 shall be satisfied.

					NOTE	APPD	CHKD	DSDG
						2010/05/25	2010/05/25	2010/05/25
SYMB	DATE	APPD	CHKD	DSGD		2010/03/23	2010/03/23	2010/03/23

L. E. D. COMMON SPECIFICATIONS

Circuit:



L. E. D. Characteristic:

1. Reverse Voltage: 5V

2.

Emitted cold	or.	Power dissination	DC Forward Current	Test conditions IF=20 mA		
Dillitted core	л	(mW)	(mA)	Forward v	oltage (V)	
		(1141)	(mm)	Тур	MAX	
	Red	60	25	2. 0	2. 4	
Red/Green/Blue	Green	110	25	3, 3	3. 7	
	Blue	110	25	3, 3	3, 7	

					NOTE	APPD	CHKD	DSDG
						2010/11/15	2010/11/15	2010/11/15
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